

## Features

- Compliant to USB specifications
- Dual independent switches control
- 2.7V to 5.5V input voltage
- 500mA minimum continuous current per port
- 110mΩ typical on-resistance
- 1.25A maximum short circuit current limit
- Independent open-drain fault flag pins
- 110  $\mu$ A typical on-state supply current
- 1  $\mu$ A typical off-state supply current
- Output can be forced higher than input (off-state)
- Thermal shutdown
- 2.4V typical under voltage lockout (UVLO)
- 1ms turn-on (soft-start) and fast turn-off
- Enable active-high (H) or active-low (L)
- SOP-8L: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/RoHS Compliant (Note 1)

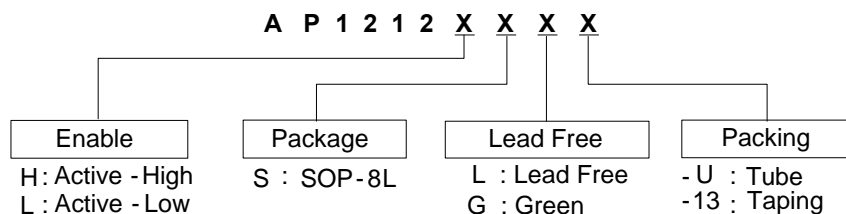
## General Description

The AP1212 series are dual integrated high-side power switch with independent enable and flag functions, optimized for self-powered and bus-powered Universal Serial Bus (USB) applications. The AP1212 series support the following USB requirements: each switch channel supplies up to 500mA as required by USB downstream devices; the switch's low on-resistance meets USB voltage drop requirements; fault current is limited to typically 1000mA, well below the UL 25VA safety requirements; and a flag output is available to indicate fault conditions to the local USB controller. Soft start eliminates the momentary voltage drop on the upstream port that may occur when the switch is enabled in bus-powered applications. Additional features include thermal shutdown to prevent catastrophic switch failure from high-current loads, under voltage lockout (UVLO) to ensure that the device remains off unless there is a valid input voltage present, and 3.3V and 5V logic compatible enable inputs.


## Applications

- USB hubs
- Hot plug-in power supplies
- Battery-charger circuits

## Ordering Information

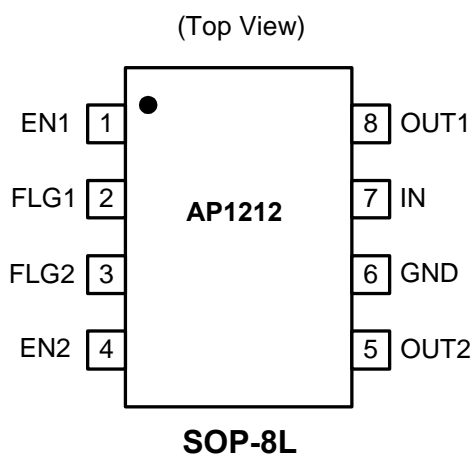


Note: 1. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.

Device (Note 3)	Package Code	Packaging	Tube		13" Tape and Reel	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix
 AP1212XS	S	SOP-8L	100	-U	2500/Tape & Reel	-13

Note: 2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

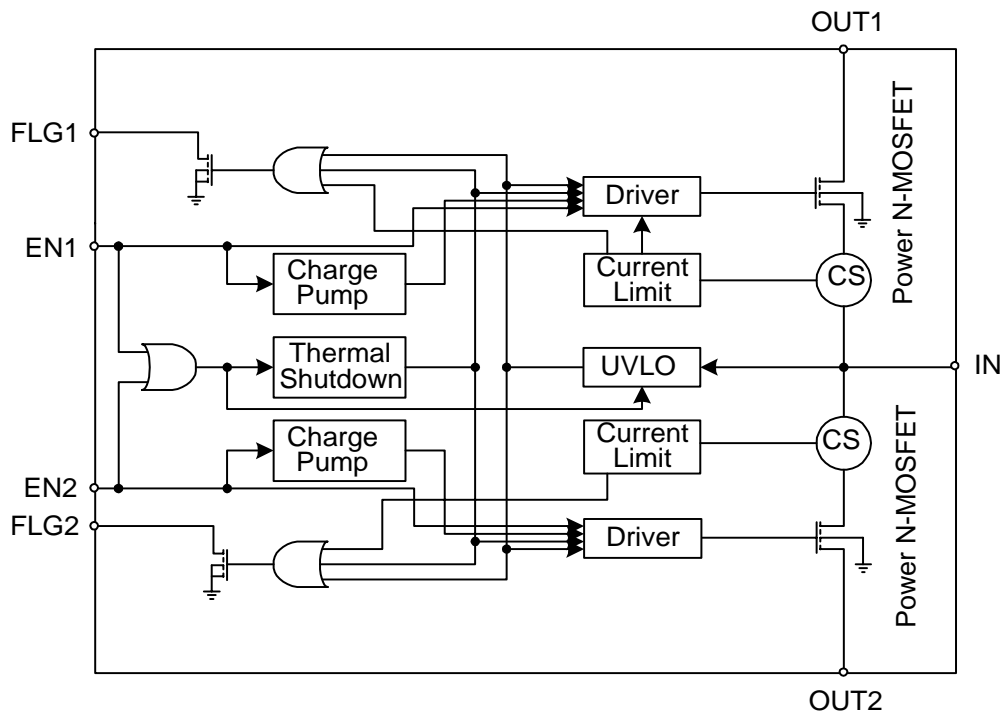
## Pin Assignments



## Pin Descriptions

Name	Description
EN1 EN2	Enable: Logic-compatible enable input. ( H: active high, L: active low). Do not float.
FLG1 FLG2	Fault Flag: Active-low, open-drain output. Indicates over current, UVLO, and thermal shutdown.
GND	Supply return.
IN	Supply Input: Output MOSFET drain. Also supplies IC's internal circuitry. Connect to positive supply.
OUT1 OUT2	Switch Output: Output MOSFET source. Typically connect to switched side of load.

## Block Diagram



## Absolute Maximum Ratings (Note 3)

Symbol	Parameter	Rating	Unit
$V_{IN}$	Supply Voltage	+7	V
$V_{FLG}$	Fault Flag Voltage	+7	V
$I_{FLG}$	Fault Flag Current	50	mA
$V_{OUT}$	Output Voltage	+7	V
$V_{EN}$	Control Input Range	-0.3 to $V_{IN} + 2$	V
$T_{ST}$	Storage Temperature	-65 to +150	°C
ESD HBM	Note 3	500	V
ESD MM	Note 3	150	V

**Operating Ratings** (Note 4)

Symbol	Parameter	Rating	Unit
$V_{IN}$	Supply Voltage	+2.7 to +5.5	V
$T_{OP}$	Operating Junction Temperature	-40 to +125	°C
$\Theta_{JA}$	Thermal Resistance SOP Junction to Ambient	165	°C/W
$\Theta_{JC}$	Thermal Resistance SOP Junction to Case	26	°C/W

Note: 3. Exceeding the absolute maximum rating may damage the device.  
 4. The device is not guaranteed to function outside its operating rating.

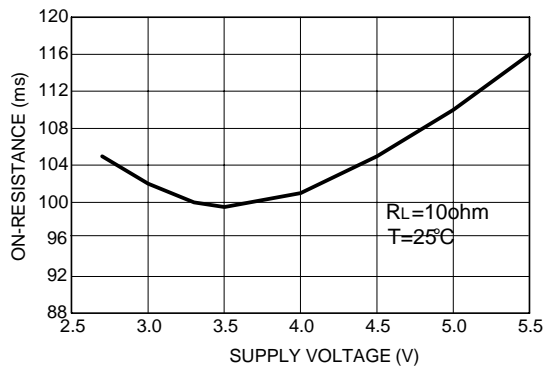
**Electrical Characteristics** (Under the conditions of  $V_{IN} = +5V$  and  $T_A = 25^{\circ}C$ , unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_{CC}$	Supply Current	Switch off, OUT = open (Note 6)		0.50	5	$\mu A$
		All switches on, OUT = open (Note 6)		110	160	$\mu A$
$V_{IT}$	Enable Input Threshold	(Note 6)	0.8	1.7	2.40	V
$I_{EN}$	Enable Input Current	$V_{EN} = 0V$ to 5.5V	-1	$\pm 0.01$	1	$\mu A$
$C_{EN}$	Enable Input Capacitance			1		pF
$R_{DS(ON)}$	Switch Resistance	$V_{IN} = 2.7V \sim 5.5V$ , $I_{OUT} = 500mA$ , each switch		110	140	m $\Omega$
$T_{OND}$	Output Turn-On Delay	$R_L = 10\Omega$ each output		30		$\mu S$
$T_R$	Output Turn-On Rise Time	$R_L = 10\Omega$ each output		1		mS
$T_{OFFD}$	Output Turnoff Delay	$R_L = 10\Omega$ each output		0.5	10	$\mu S$
$T_F$	Output Turnoff Fall Time	$R_L = 10\Omega$ each output		0.5	10	$\mu S$
$I_{LEAK}$	Output Leakage Current	Each output (output disabled)			10	$\mu A$
$I_{OUT}$	Continuous Load Current	Each output	0.6			A
$I_{OS}$	Short-circuit Current Limit	Each output (enable into load), $V_{OUT} = 0V$	0.8	1.0	1.25	A
$I_{LIM}$	Current-Limit Threshold	Ramped load applied to enabled output	1.0	1.2	1.4	A
$T_{TS}$	Over-temperature Shutdown Threshold	$T_J$ increasing		140		°C
		$T_J$ decreasing		130		°C
$R_{FO}$	Error Flag Output Resistance	$V_{IN} = 5V$ , $I_L = 10mA$		10	25	$\Omega$
		$V_{IN} = 3.3V$ , $I_L = 10mA$		15	40	$\Omega$
$I_{FOH}$	Error Flag Off Current	$V_{FLAG} = 5V$		0.01	1	$\mu A$
UVLO	UVLO Threshold	$V_{IN} =$ increasing		2.5		V
		$V_{IN} =$ decreasing		2.3		V

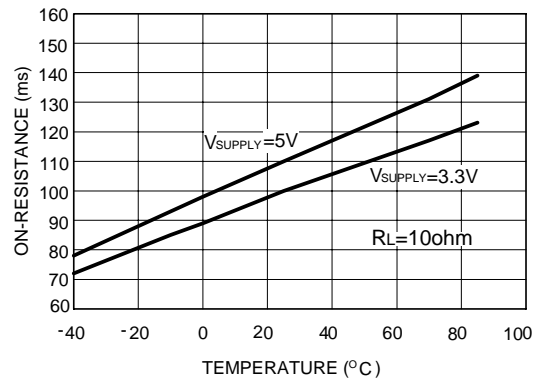
Note: 5. Devices are ESD sensitive. Handling precautions are recommended. Human Body model, tested per JEDEC 22-A114.  
 Machine model, tested per JEDEC 22-A115.  
 6. Off is  $V_{EN} \leq 0.8V$  and on is  $V_{EN} \geq 2.4V$  for the AP1212H. Off is  $V_{EN} \geq 2.4V$  and on is  $V_{EN} \leq 0.8V$  for the AP1212L.

### Typical Performance Characteristics

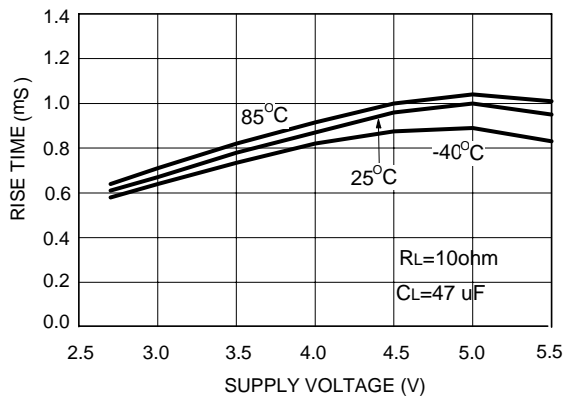
On-Resistance vs. Supply Voltage



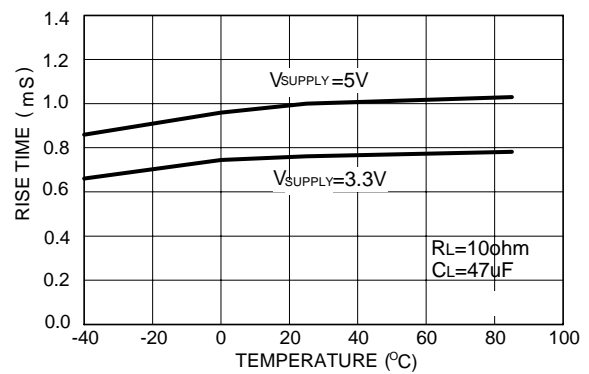
On-Resistance vs. Temperature



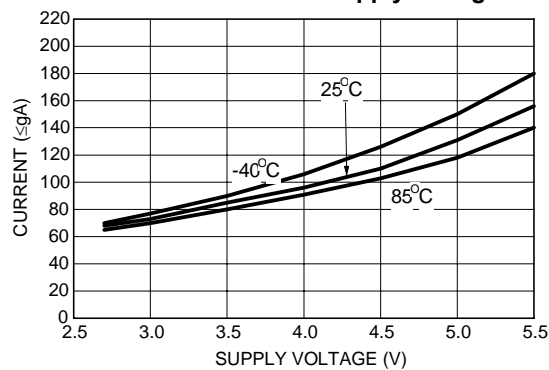
Turn-On Rise Time vs. Supply Voltage



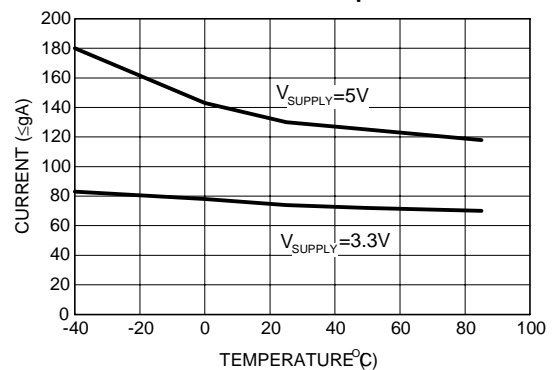
Turn-On Rise Time vs. Temperature



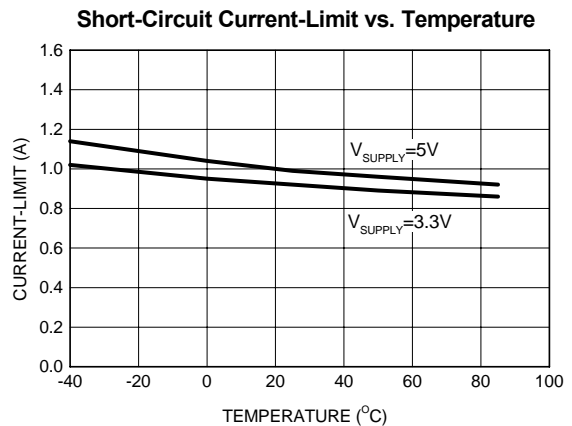
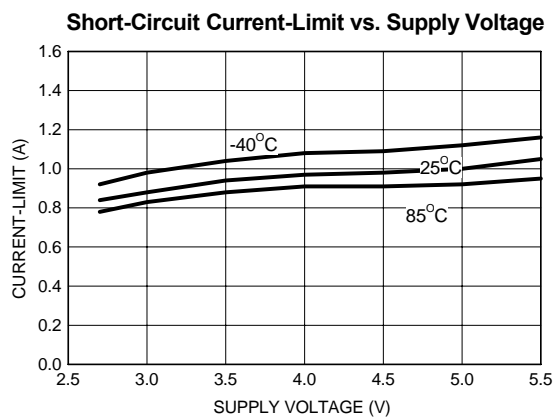
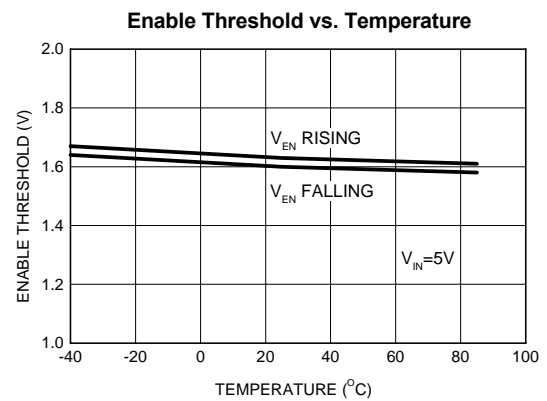
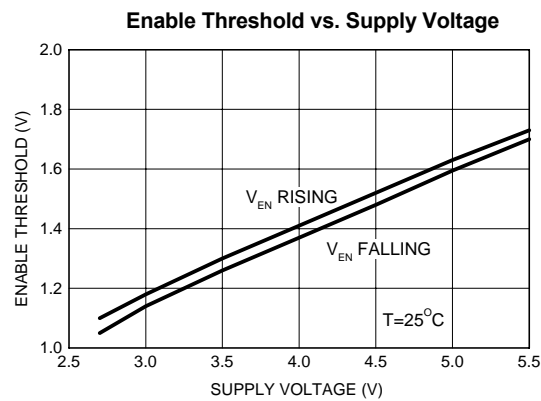
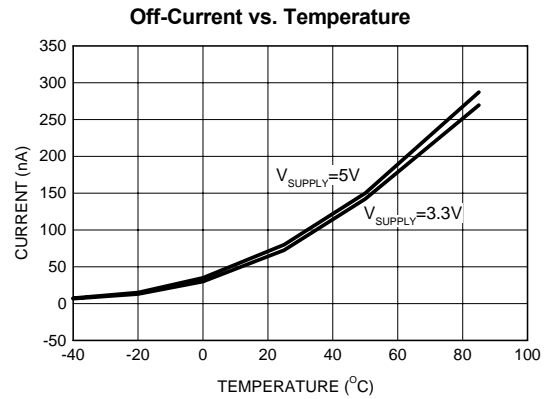
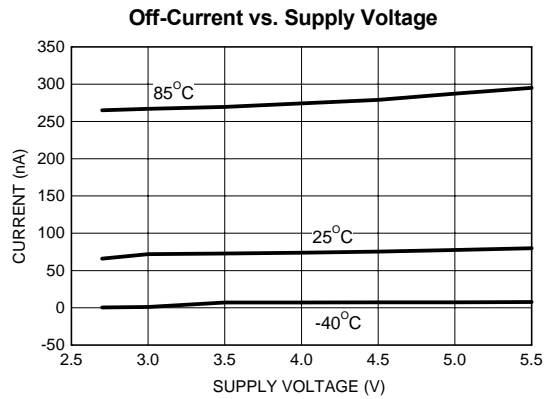
On-Current vs. Supply Voltage



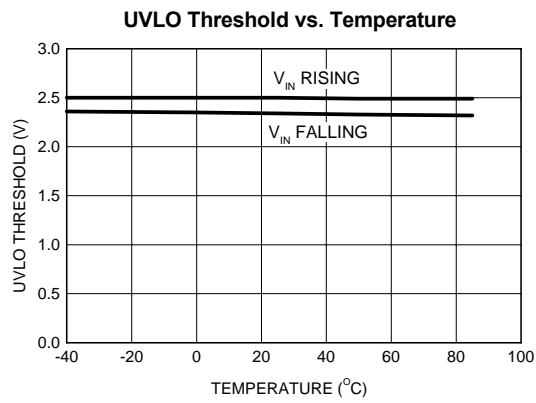
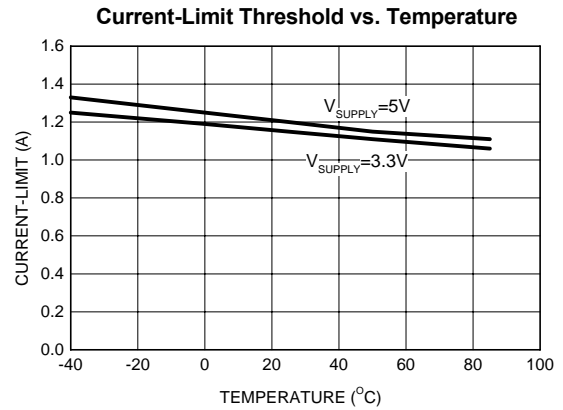
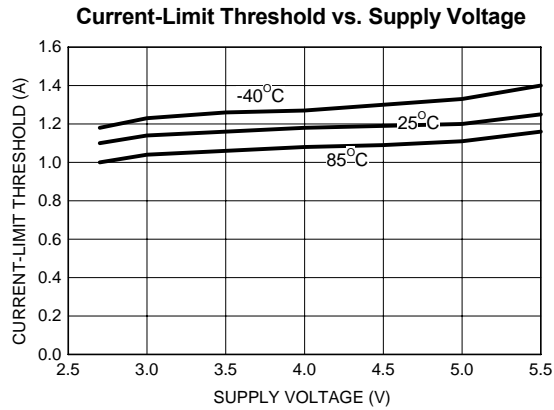
On-Current vs. Temperature



### Typical Performance Characteristics (Continued)

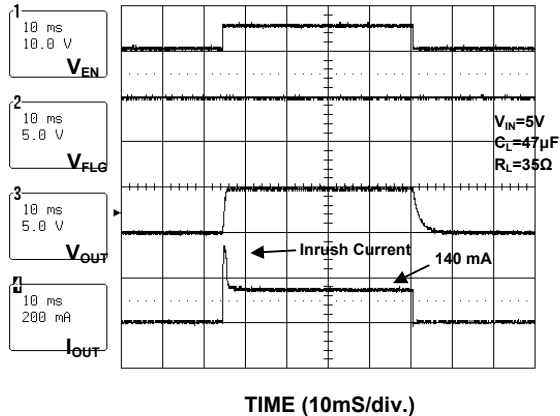


**Typical Performance Characteristics** (Continued)

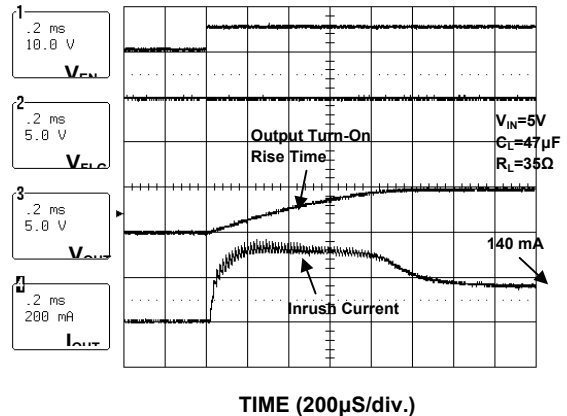


### Functional Characteristics

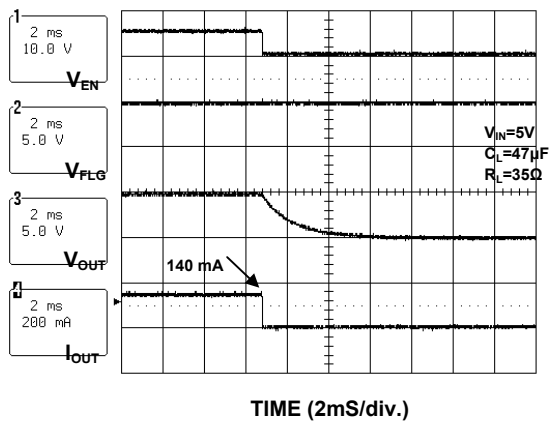
Turn-On/Turn-Off (AP1212H)



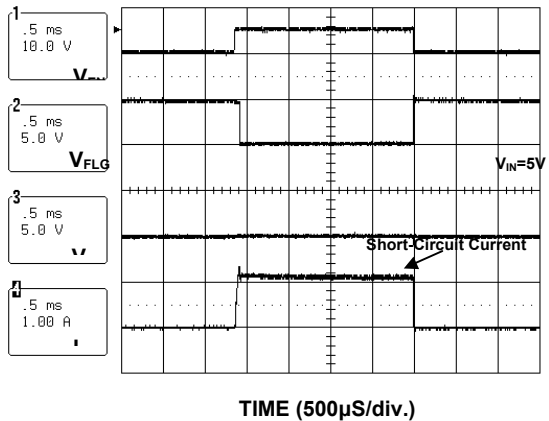
Turn-On (AP1212H)



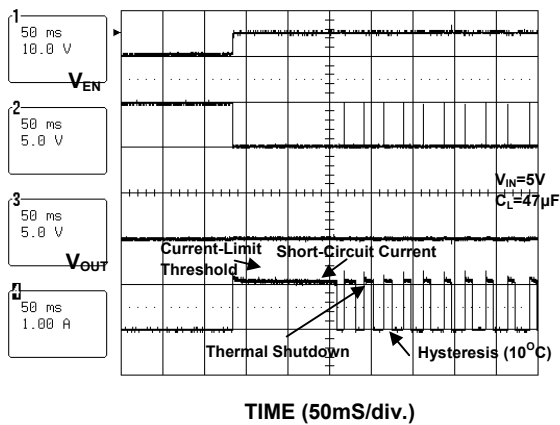
Turn-Off (AP1212H)



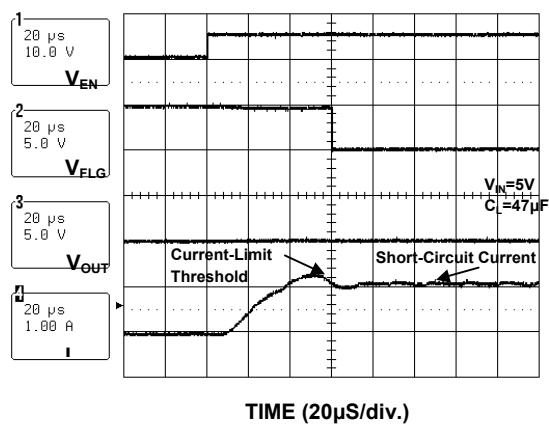
Enabled Into Short (AP1212H)



Current-Limit Response (AP1212H)

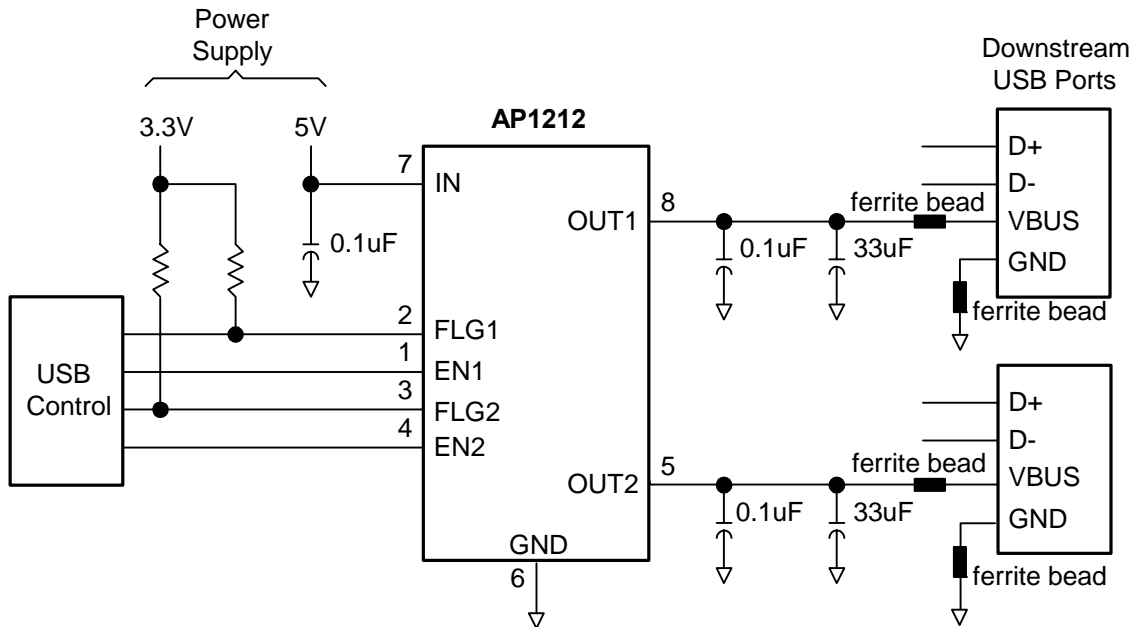


Current-Limit Response (AP1212H)

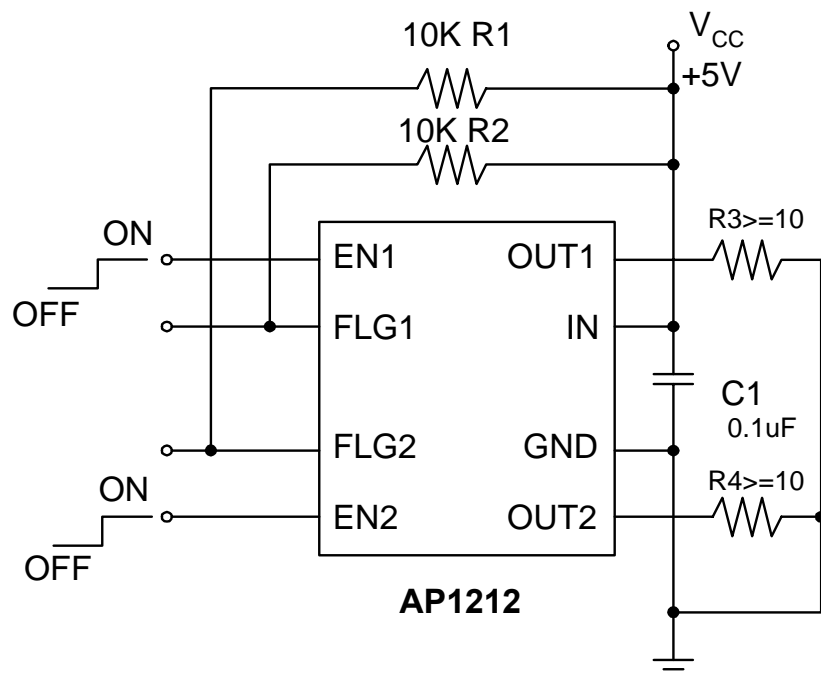




## Typical Application Circuit



## Test Circuit



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## Function Description

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### Error Flag

An open-drained output of N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input undervoltage, output current limit, and thermal shutdown.

### Current Limit

The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the AP1212 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

### Thermal Shutdown

When the chip temperature exceeds 140°C for any reason other than over current fault of either one of the two MOSFET switches, the thermal shutdown function turns off both MOSFET switches and signals the error flag. A hysteresis of 10°C prevents the MOSFETs from turning back on until the chip temperature drops to below 130°C.

### Supply Filtering

A 0.1μF to 1μF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

### Transient Droop Requirements

USB applications support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

### Short Circuit Transient

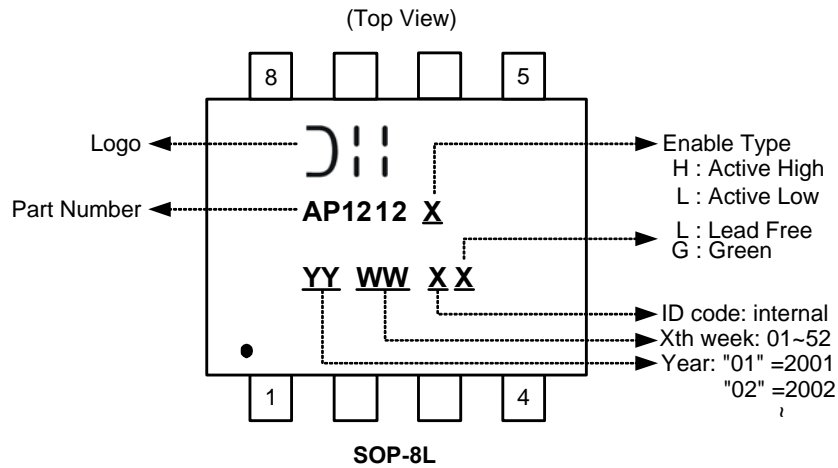
Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a 33μF, 16V tantalum or 100μF, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

### Printed Circuit Layout

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

## Marking Information

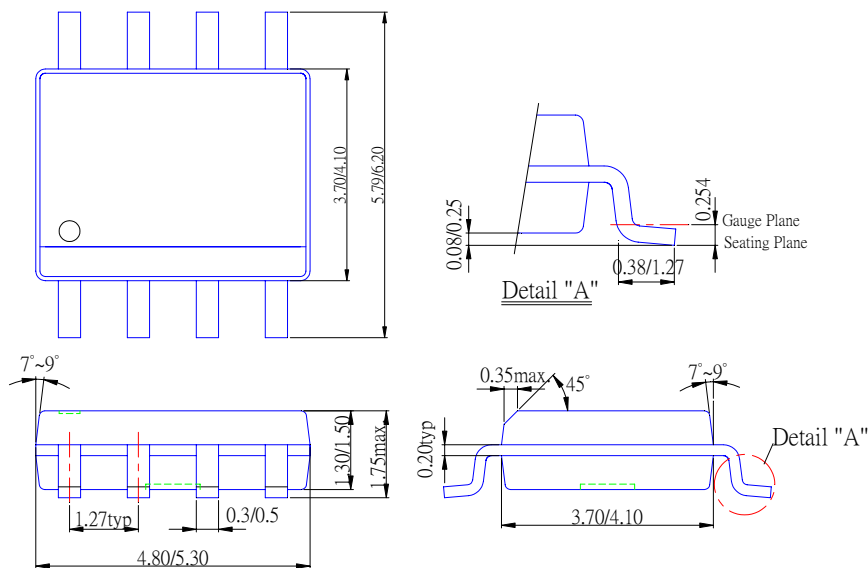
### SOP-8L



Device	Package	Identification Code
AP1212XS	SOP-8L	AP1212

## Package Information

### Package Type: SOP-8L



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